PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	Termination and Release of Security Interest in Patent Rights

CONVEYING PARTY DATA

Name	Execution Date
JPMorgan Chase Bank, N.A., as General Administrative Agent	12/22/2006

RECEIVING PARTY DATA

Name:	Lear Corporation EEDS and Interiors
Street Address:	21557 Telegraph Road
City:	Southfield
State/Country:	MICHIGAN
Postal Code:	48034

PROPERTY NUMBERS Total: 1

Property Type	Number
Patent Number:	5863370

CORRESPONDENCE DATA

Fax Number: (212)455-2502

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: (212) 455-7609

Email: ksolomon@stblaw.com
Correspondent Name: Kirstie Howard, Esq.

Address Line 1: Simpson Thacher & Bartlett LLP

Address Line 2: 425 Lexington Avenue

Address Line 4: New York, NEW YORK 10017

ATTORNEY DOCKET NUMBER:	509265/0024
NAME OF SUBMITTER:	Kirstie Howard

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TERMINATION AND RELEASE OF SECURITY INTEREST IN PATENT RIGHTS

TERMINATION AND RELEASE effective as of December 22, 2006, from JPMorgan Chase Bank, N.A., a national banking association, as General Administrative Agent (the "Agent") for certain banks and other financial institutions (the "Lenders"), to Lear Corporation EEDS and Interiors, a Delaware corporation, located at 21557 Telegraph Road, Southfield, Michigan 48034 ("Borrower").

WITNESSETH:

WHEREAS, pursuant to the Security Agreement, dated as of April 25, 2006, made by the Borrower (as defined therein) in favor of the Agent (the "Security Agreement"), a security interest (the "Security Interest") was granted by the Borrower to the Agent in certain collateral, including the Patent Collateral (as hereinafter defined);

WHEREAS, pursuant to that certain Grant of Security Interest in Patent Rights dated as of April 25, 2006, among the Agent and Borrower (the "Patent Security Agreement"), Borrower, by reference to the Security Agreement, reaffirmed its intent to grant a Security Interest to the Agent specifically in certain Patent Collateral;

WHEREAS, the Security Agreement was recorded in the Patent Division of the United States Patent and Trademark Office on June 23, 2006, at Reel 017833 and Frame 0198; and

WHEREAS, the Agent now desires to terminate and release the entirety of its Security Interest in the Patent Collateral;

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy of which are hereby acknowledged, and upon the terms set forth in this Termination and Release, the Agent hereby states as follows:

- 1. <u>Definitions</u>. The term "Patent Collateral," as used herein, shall mean all of the Borrower's right, title and interest of every kind and nature as of the date hereof in the Patents listed on Schedule 1 hereto. The term "Patent" shall have the meaning provided by reference in the Security Agreement and the Patent Security Agreement. For the avoidance of doubt, "Patent Collateral" shall not include any Patent listed on Schedule A to the Patent Security Agreement other than the Patents listed on Schedule 1 hereto.
- 2. <u>Release of Security Interest</u>. The Agent hereby terminates, releases and discharges its Security Interest in the Patent Collateral, and any right, title or interest of the Agent in such Patent Collateral shall hereby cease and become void.
- 3. <u>Further Assurances</u>. The Agent hereby agrees to duly execute, acknowledge, procure and deliver any further documents and to do such other acts as may be reasonably necessary to effect the release of the Security Interest contemplated hereby.

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IN WITNESS WHEREOF, the undersigned has executed this Termination and Release by its duly authorized officer as December 22,2006.

JPMORGAN CHASE BANK, N.A.

By: Thousand Comits

Name: Richard C. Shorth,

Title: Vice President

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STATE OF New YORK)	
COUNTY OF New YORK)	SS.:

On this 22 day of December, 2006, before me personally appeared Nichard C. San Ha to me known who, being by me duly sworn, did depose and say that he/she is <u>Vice President</u> of JPMorgan Chase Bank, N.A., described herein and which executed the foregoing instrument, and that he/she signed his/her name thereto pursuant to the authority granted by JPMorgan Chase Bank, N.A.

Kathleen W. Sean Notary Public

(Affix Seal Below)

KATHLEEN M. KEAN
Notary Public, State Of New York
No. 01KE4927080
Qualified In Westchester County
Commission Expires April 11, 20

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Schedule 1

U.S. Patents and Patent Applications

Patent or Application Number	Title	
5,863,370	Method of bonding cloth cover to substrate base	

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RECORDED: 12/26/2006

PATENT REEL: 018668 FRAME: 0812